

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
LI-CHUAN TSENG	09/21/2015
RECEIVING PARTY DATA	
Name:	MEDIATEK INC.
Street Address:	NO. 1 DUSING RD. 1ST.
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14863533
CORRESPONDENCE DATA	
Fax Number:	(925)835-5804
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	408 896 6196
Email:	zheng@imperiumpw.com
Correspondent Name:	LAW OFFICE OF ZHENG JIN
Address Line 1:	P.O.BOX 731450
Address Line 4:	SAN JOSE, CALIFORNIA 95173
ATTORNEY DOCKET NUMBER:	MDT-221
NAME OF SUBMITTER:	ZHENG JIN
SIGNATURE:	/zheng jin/
DATE SIGNED:	09/24/2015
Total Attachments: 1	
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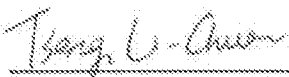
ASSIGNMENT OF PATENT APPLICATION

WHEREAS, I, having a post office address that follows my name: Li-Chuan Tseng, 3F., No.155-1, Leye St., Da'an Dist., Taipei City 106, Taiwan (hereinafter referred to as ASSIGNOR), am the sole inventor of the invention described and claimed in the specification forming part of the United States patent application entitled "RRC RE-ESTABLISHMENT ON SECONDARY ENODEB FOR DUAL CONNECTIVITY," executed herewith;

WHEREAS, MEDIATEK INC. (hereafter referred to as ASSIGNEE), a corporation organized under the laws of Taiwan and having a place of business at No. 1, Dusing Rd. 1st, Hsinchu Science Park, Hsin-Chu 300, Taiwan, is desirous of acquiring the entire right, title, and interest in and to the invention and in and to any letters patents that may be granted thereof in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby sells, assigns, and transfers unto said ASSIGNEE, the entire right, title, and interest in and to said invention, said application and any and all letters patents which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty, or otherwise, said invention, application and all letters patents on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors an assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR had this assignment, transfer, and sale not been made. ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all letters patents on said invention to ASSIGNEE. ASSIGNOR agrees to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patents on said invention, for litigation regarding said letters patents, or for the purpose of protecting title to said invention or letters patents therefor.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.


Inventor's Signature

Li-Chuan Tseng
Inventor's Printed Name

2015. 9. 21
Date